



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

International **IR** Rectifier

PD - 95326

IRG4IBC30WPbF

INSULATED GATE BIPOLAR TRANSISTOR

Features

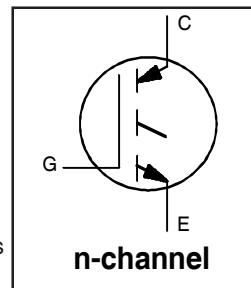
- Designed expressly for Switch-Mode Power Supply and PFC (power factor correction) applications
- 2.5kV, 60s insulation voltage ⑥
- Industry-benchmark switching losses improve efficiency of all power supply topologies
- 50% reduction of E_{off} parameter
- Low IGBT conduction losses
- Latest-generation IGBT design and construction offers tighter parameters distribution, exceptional reliability
- Industry standard Isolated TO-220 Fullpak™ outline
- Lead-Free

Benefits

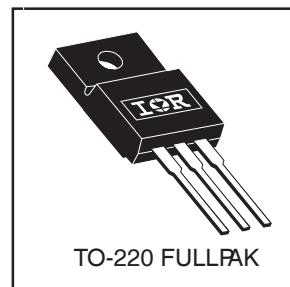
- Lower switching losses allow more cost-effective operation than power MOSFETs up to 150 kHz ("hard switched" mode)
- Of particular benefit to single-ended converters and boost PFC topologies 150W and higher
- Low conduction losses and minimal minority-carrier recombination make these an excellent option for resonant mode switching as well (up to >>300 kHz)

Absolute Maximum Ratings

	Parameter	Max.	Units
V _{CES}	Collector-to-Emitter Breakdown Voltage	600	V
I _C @ T _C = 25°C	Continuous Collector Current	17	A
I _C @ T _C = 100°C	Continuous Collector Current	8.4	
I _{CM}	Pulsed Collector Current ①	92	
I _{LM}	Clamped Inductive Load Current ②	92	
V _{GE}	Gate-to-Emitter Voltage	± 20	V
E _{ARV}	Reverse Voltage Avalanche Energy ③	180	mJ
P _D @ T _C = 25°C	Maximum Power Dissipation	45	W
P _D @ T _C = 100°C	Maximum Power Dissipation	18	
T _J	Operating Junction and	-55 to + 150	°C
T _{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm from case))	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 2.1V$
 @ $V_{GE} = 15V, I_C = 12 A$



Thermal Resistance

	Parameter	Typ.	Max.	Units
R _{θJC}	Junction-to-Case - IGBT	—	2.8	°C/W
R _{θJA}	Junction-to-Ambient, typical socket mount	—	65	
Wt	Weight	2.0 (0.07)	—	

IRG4IBC30WPbF

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage ④	18	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.34	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	2.1	2.7	V	$I_C = 12\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.45	—		$I_C = 23\text{A}$ See Fig.2, 5
		—	1.95	—		$I_C = 12\text{A}, T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ⑤	11	16	—	S	$V_{\text{CE}} = 100\text{ V}, I_C = 12\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}$
		—	—	2.0		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}, T_J = 25^\circ\text{C}$
		—	—	1000		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}, T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	51	76	nC	$I_C = 12\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	7.6	11		$V_{\text{CC}} = 400\text{V}$ See Fig.8
Q_{gc}	Gate - Collector Charge (turn-on)	—	18	27		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	25	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 12\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 23\Omega$
t_r	Rise Time	—	16	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	99	150		
t_f	Fall Time	—	67	100		
E_{on}	Turn-On Switching Loss	—	0.13	—	mJ	Energy losses include "tail" See Fig. 9, 10, 13, 14
E_{off}	Turn-Off Switching Loss	—	0.13	—		
E_{ts}	Total Switching Loss	—	0.26	0.35		
$t_{d(\text{on})}$	Turn-On Delay Time	—	24	—	ns	$T_J = 150^\circ\text{C},$ $I_C = 12\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 23\Omega$ Energy losses include "tail"
t_r	Rise Time	—	17	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	150	—		
t_f	Fall Time	—	150	—		
E_{ts}	Total Switching Loss	—	0.55	—	mJ	See Fig. 11, 13, 14
L_E	Internal Emitter Inductance	—	7.5	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	980	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
C_{oes}	Output Capacitance	—	71	—		
C_{res}	Reverse Transfer Capacitance	—	18	—		

Notes:

- ① Repetitive rating; $V_{\text{GE}} = 20\text{V}$, pulse width limited by max. junction temperature. (See fig. 13b)
- ② $V_{\text{CC}} = 80\%(V_{\text{CES}})$, $V_{\text{GE}} = 20\text{V}$, $L = 10\mu\text{H}$, $R_G = 23\Omega$, (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.
- ⑥ $t = 60\text{s}$, $f = 60\text{Hz}$

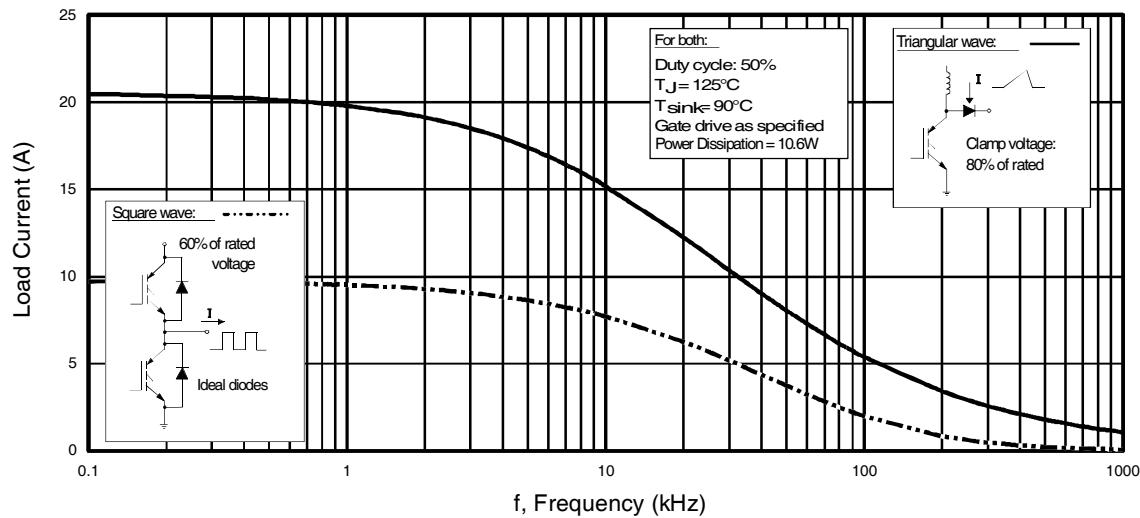


Fig. 1 - Typical Load Current vs. Frequency
 (For square wave, $I=I_{RMS}$ of fundamental; for triangular wave, $I=I_{PK}$)

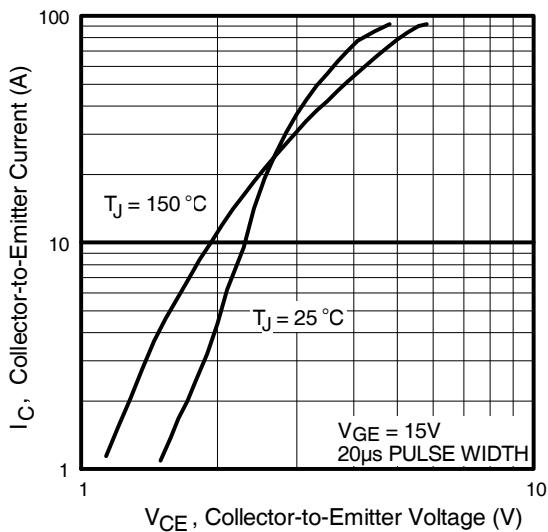


Fig. 2 - Typical Output Characteristics

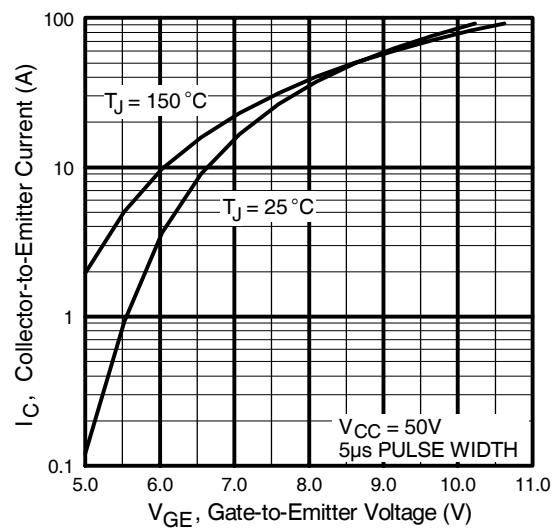


Fig. 3 - Typical Transfer Characteristics

IRG4IBC30WPbF

International
IR Rectifier

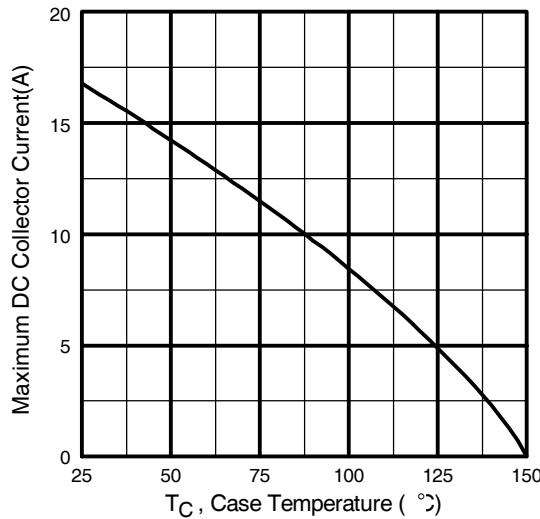


Fig. 4 - Maximum Collector Current vs. Case Temperature

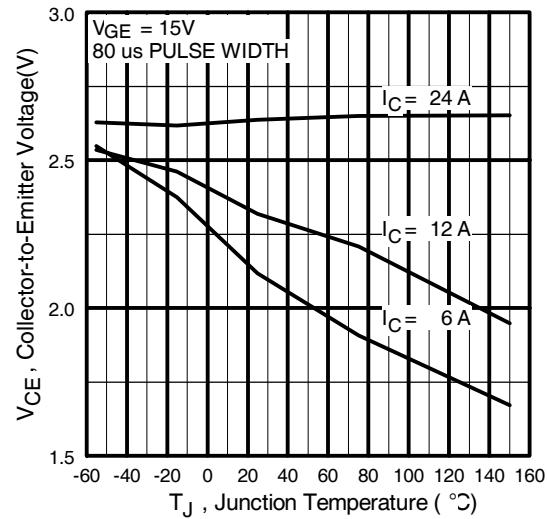


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

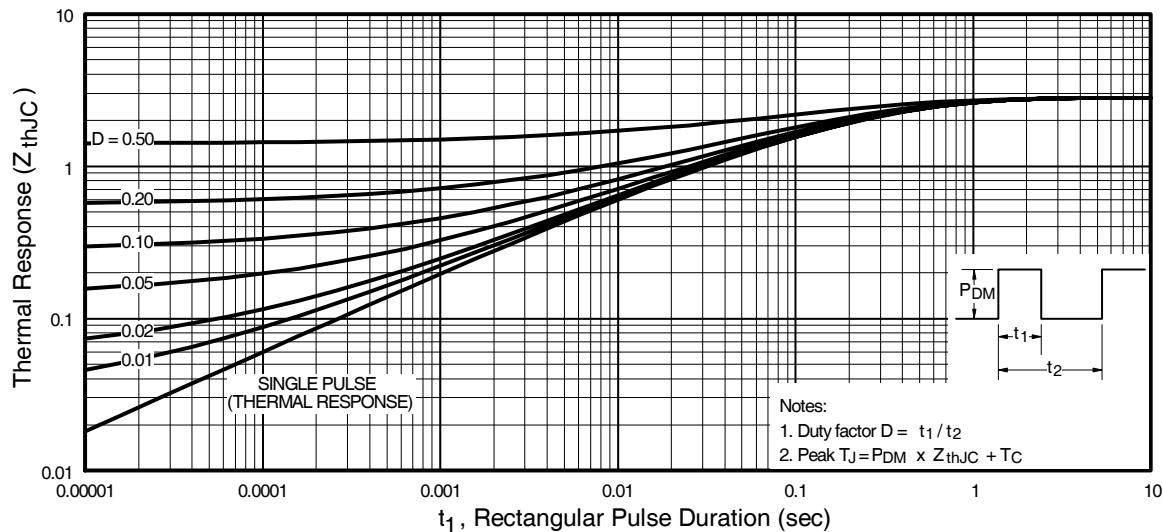
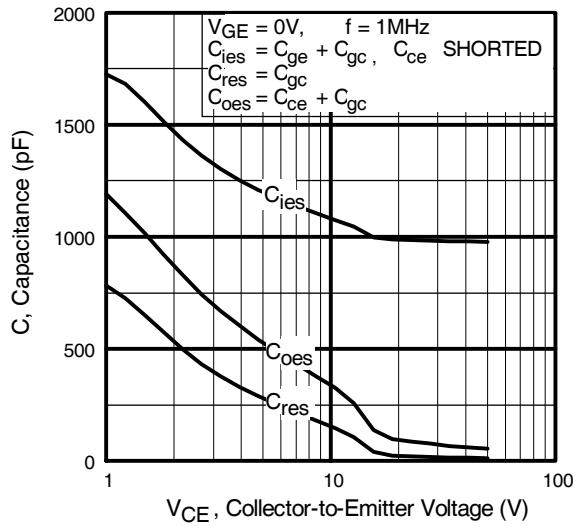
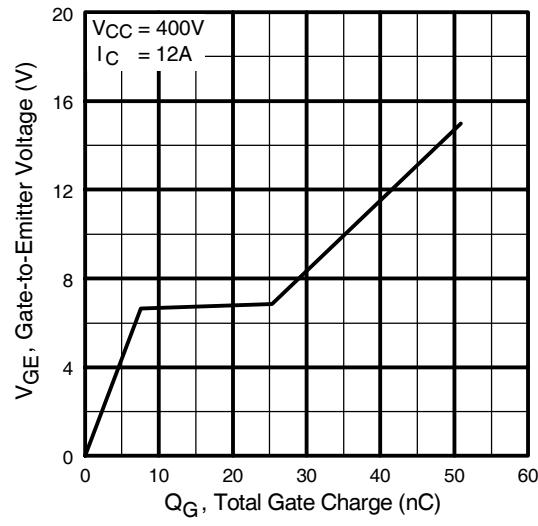


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

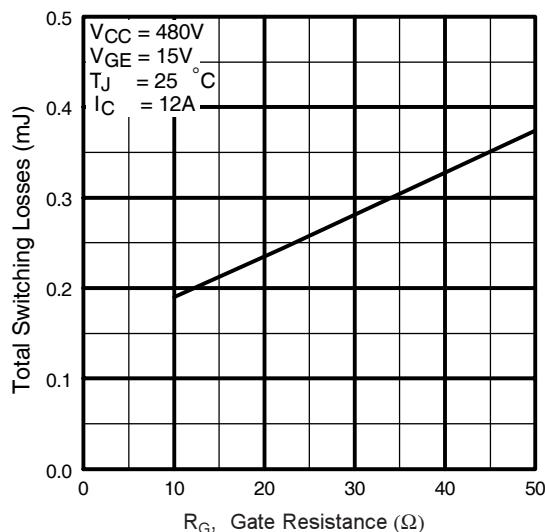
IRG4IBC30WPbF



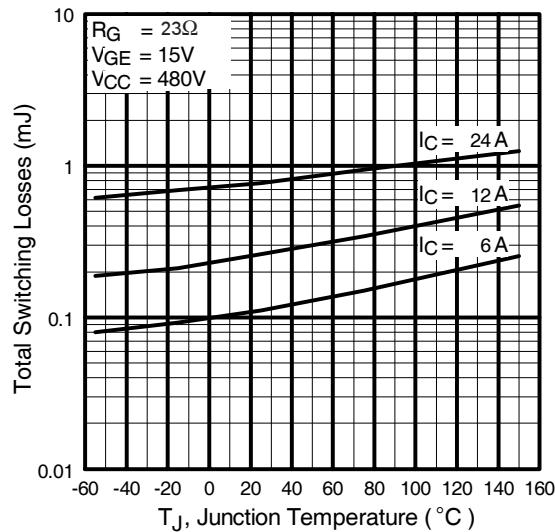
**Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage**



**Fig. 9 - Typical Switching Losses vs. Gate
Resistance**



**Fig. 10 - Typical Switching Losses vs.
Junction Temperature**

IRG4IBC30WPbF

International
IR Rectifier

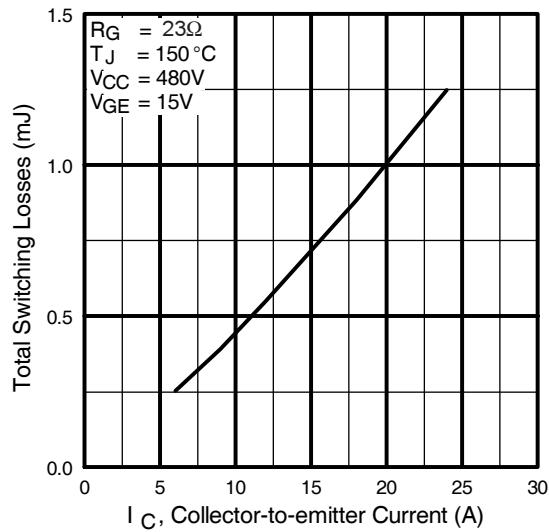


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

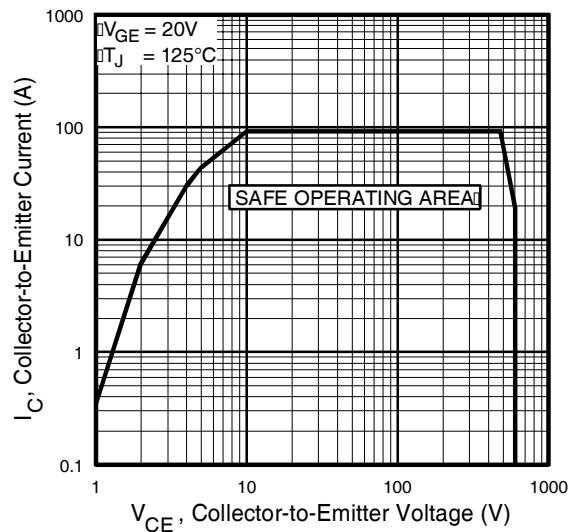
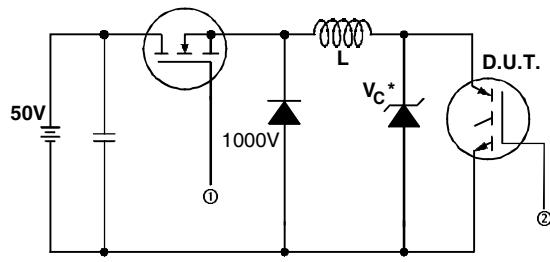


Fig. 12 - Turn-Off SOA



* Driver same type as D.U.T.; $V_c = 80\%$ of $V_{ce(max)}$
 * Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated I_d .

Fig. 13a - Clamped Inductive Load Test Circuit

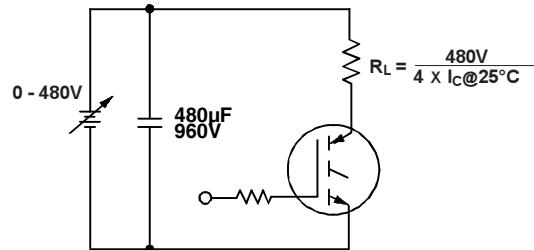


Fig. 13b - Pulsed Collector Current Test Circuit

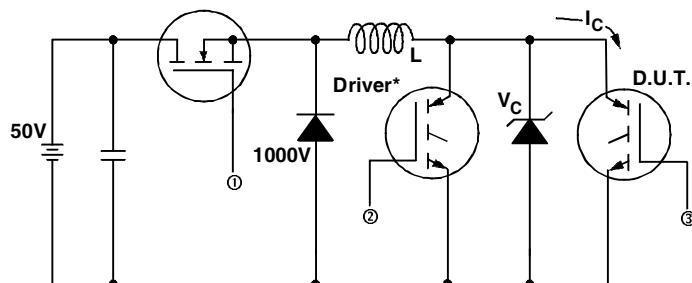


Fig. 14a - Switching Loss Test Circuit

* Driver same type as D.U.T., $V_C = 480V$

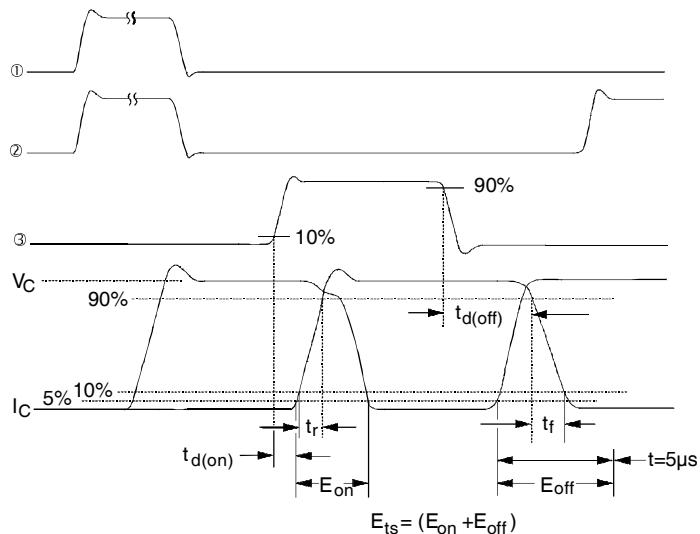


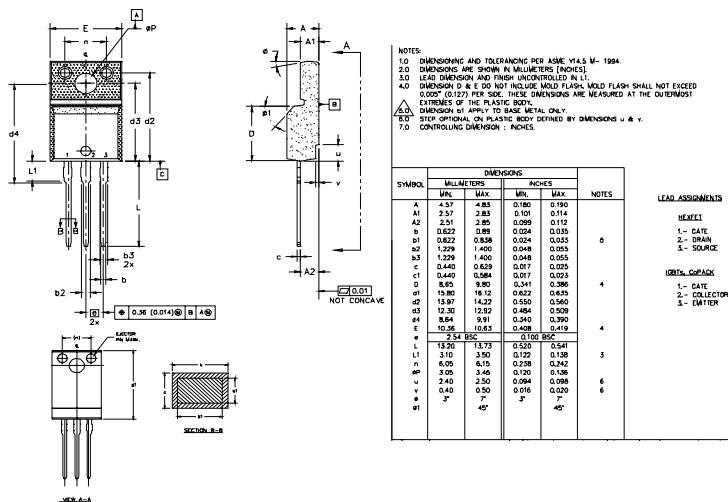
Fig. 14b - Switching Loss Waveforms

IRG4IBC30WPbF

International
IR Rectifier

TO-220 Full-Pak Package Outline

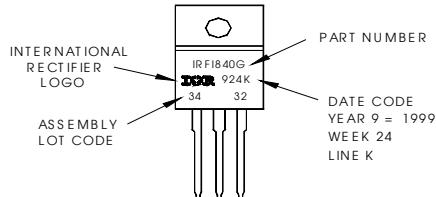
Dimensions are shown in millimeters (inches)



TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRF1840G
WITH ASSEMBLY
LOT CODE 3432
ASSEMBLED ON WW 24 1999
IN THE ASSEMBLY LINE "K"

Note: "P" in assembly line
position indicates "Lead-Free"



International
IR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.
Data and specifications subject to change without notice. 06/04

Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>